

(0.80 mm) .0315"

ERF8 SERIES

RUGGED HIGH-SPEED SOCKET

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?ERF8

Insulator Material: Black LCP

Contact Material:

Plating:

Au or Sn over 50 μ" (1.27 μm) Ni

Current Rating: 2.2 A per pin (2 pins powered)

Operating Temp Range: -55 °C to + 125 °C

Voltage Rating: 225 VAC / 318 VDC RoHS Compliant:

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (005-030) (0.12 mm) .005" max (040-060)* (0.15 mm) .006" max (070-100) *(.004" stencil solution may be available; contact IPG@samtec.com)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



PROTOCOLS

- 100 GbE
- PCI Express[®]

STANDARD

NEXUS5001™.org

NEXUS5001™.org

Some lengths, styles and options are non-standard,

POWER.org"

ARM/HSSTP

POWER.org

non-returnable.

Notes:

Patented

ALSO AVAILABLE (MOQ Required)

APPLICATIONS

POS. PART NOs.

10 ASP-148421-01

ASP-137973-01

ASP-130367-01

11 | ASP-137969-01 | ERF8-DV

23 | ASP-130368-01 | ERF8-DV

25 ASP-148422-01 ERF8-DV

35 ASP-135029-01 ERF8-DV

40 ASP-148424-01 ERF8-DV

SERIES

ERF8-DV

ERF8-DV

ERF8-DV

· Mezzanine stack heights Contact Samtec

Board Mates:

Cable Mates:

ERCD, ERDF



ERF8	ERM8 LEAD STYLE			
LEAD STYLE	-02.0	-05.0	-08.0	-09.0
-05.0	(7.00)	(10.00)	(13.00)	(14.00)
	.276	.394	.512	.551
-07.0	(9.00)	(12.00)	(15.00)	(16.00)
	.354	.472	.591	.629
-09.0	(11.00)	(14.00)	(17.00)	(18.00)
	.453	.551	.669	.709
*Processing conditions will affect mated height.				

HIGH-SPEED CHANNEL PERFORMANCE PAM4

ERM8/ERF8 @ 7 mm Mated Stack Height

Rating based on Samted reference channel.
For full SI performance data visit Samtec.com or contact SIG@samtec.com

POWER/SIGNAL **APPLICATION**

(1.50 mm)

.059" NOMINAL



Compatible with UMPT/UMPS for flexible two-piece power/signal solutions

STYLE

LEAD

PLATING OPTION

DV

OTHER OPTION

·TR

=Tape &

Reel

Packaging

(Not

available with 100

positions)

-005, -010, -011,–013. –020. –025. -030, -035 -040, -049 050, -060, -070, -075

NO. OF POSITIONS

PER ROW

(Available with -05.0 lead style only)

No. of Positions x

-L & -EGP = No. of Positions x(0.80) .0315 + (7.50) .295

-EGPS = No. of Positions x

 $(0.80) \cdot 0315 + (10.00) \cdot 394$

(0.80) .0315 + (6.00) .236

LEAD STYLE from chart

LEAD STYLE	Α	
-05.0	(5.10) .200	
07.0	(7.00) .276	
-09.0	(9.00) .354	

(5.60)

= 10 μ" (0.25 µm) Gold on contact, **Matte Tin** on tail

-S
= 30 µ"
(0.76 µm)
Gold on
contact,
Matte Tin
on tail

(7.25)

.285

= Latching (Not available with -EGP or -EGPS options & Lead Style -07)

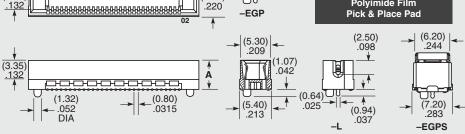
-EGP

= Extended Guide Post (Lead Style -07.0 only) (Not available with -L & -EGPS option)

-EGPS

= Extended Guide Post Shield (Lead Style -05.0 & -07.0 only) (Not available with -L & –EGP option) (-010, -020, -025, -030 only)

= (6.00 mm) .236" DIA Polyimide Film



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WWW.SAMTEC.COM